

UK Activities on CMOS MAPS

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Rutherford Appleton Laboratory

- 1 Production MAPS sensors
- 2 Prototype MAPS sensors
- 3 Conclusion and Future

Recent R&D Collaborations

- **CALICE-UK (ILC calorimetry)**: Birmingham, Cambridge, Manchester, RAL/STFC, Imperial College (IC), University College, Royal Holloway.
- **SPiDer (vertexing/tracking at LC)**: Bristol, Birmingham, IC, Oxford, Queen Mary, RAL/STFC.
- **Arachnid (generic vertexing/tracking/calorimetry)**: Bristol, Birmingham, Queen Mary, RAL/STFC, Daresbury/STFC.
- **Low-Mass and Plume (low-mass structures)**: RAL/STFC, Bristol, Oxford with DESY, IPHC/Strasbourg, IK-Frankfurt.
- **UK MAPS (LC sensor testing)**: Bristol, Queen Mary, RAL/STFC. Awaiting outcome of grant request.

Monolithic Active Pixel Sensors (MAPS)

Useful Features

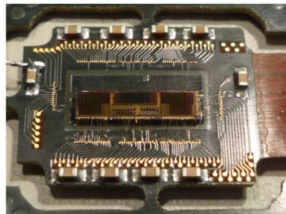
- **Low Cost:** 0.18 μm CMOS, mature industrial process.
- **Low Power:** low voltage and absence of standing currents.
- **Low Material:** very thin overall (30-50 μm).
- **Radiation Tolerant:** Achilles sensor is tolerant to 20 Mrad.
- **High Granularity:** pixel sizes down to $\sim 1 \mu\text{m}$.

Additional Features developed

- **Deep p-well/InMAPS:** improved charge collection.
- **High resistivity epitaxial layers:** radiation hardness, improved charge collection.
- **4T structures:** in-pixel structures, correlated double sampling (CDS), improved S/N, low power (effectively $10 \mu\text{W}/\text{row}$).
- **Stitching:** large structures (13.9 cm \times 12 cm have been achieved).

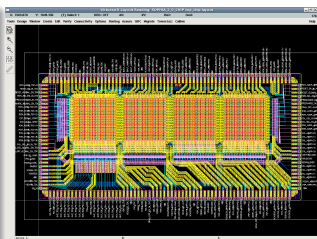
Highly Miniaturised Radiation Monitor

- Sensor size : $50 \times 50 \mu\text{m}$, $250 \mu\text{m}$ thick, 10.3 mm by 2.4 mm .
- Low noise, rad tolerant, designed for ESA.
- To be launched on Tech Demo Satellite.



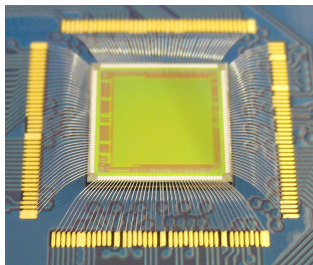
Single Photon Avalanche Detectors

- $0.18 \mu\text{m}$ CMOS, alternative to APDs and CCDs.
- Targetting FLIM, 3D imaging, astronomy, PET and mass spectroscopy.
- Photon Detection Probability up to 27%
- Timing resolution: 0.5 ns FWHM.



PImMS 1 & 2 - Pixel Imaging Mass Spectroscopy

- Based on TPAC.
- Event-based time-stamping pixel sensor.
- 382×382 $70 \mu\text{m}$ pixels.
- 80MHz, 12.5 ns time resolution.
- 12 bit timestamp storage.
- 4 registers per pixel for multiple event detection.
- Per pixel trim, mask and comparator.
- Analogue readout for focusing and event size measurement.
- Gadolinium thin film coating used in neutron imaging.

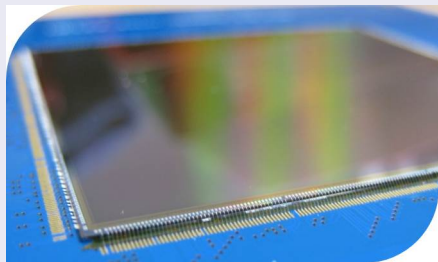


PiMMS 1 camera

Achilles for TEM and Lassena for X-ray imaging

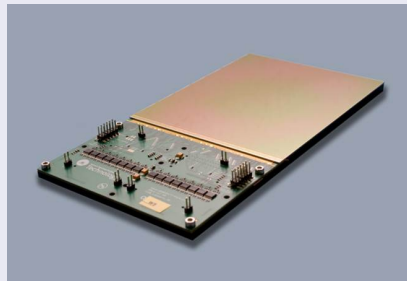
Transmission Electron Microscope

- 4096 × 4096 14 μm pixels
- Sensor Size: 61 mm × 63 mm
- Analogue output, 40 fps.
- Radiation Hard to 20 Mrad.



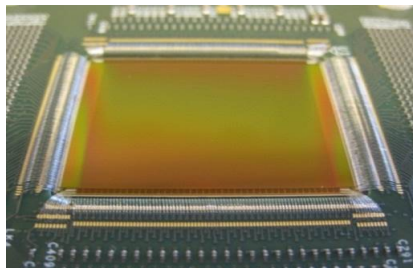
X-ray Imaging

- 2800 × 2400 50 μm pixels.
- 139.2 mm × 120 mm.
- Analogue output, 30 fps.
- 3-side buttable with minimal dead space.



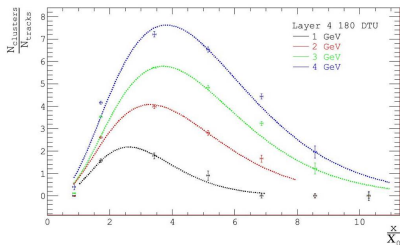
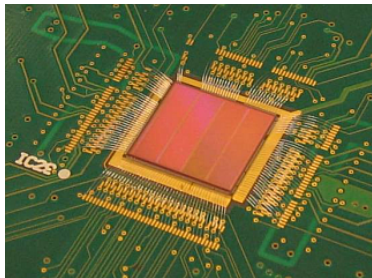
Kirana - Ultra High Speed Imaging Sensor

- 924×768 , $30 \mu\text{m}$ pixels.
- Die size: $32.5 \times 25.5 \text{ mm}$.
- CDS, in-pixel storage.
- Continuous readout at 1,180 fps.
- **Burst mode: 180 frames at 2 MHz (but sensor will work at 5 MHz).**
- Gain: $80 \mu\text{V}/e^-$.
- Full well: $11,700e^-$.
- Commercialised (Specialised Imaging).



Tera-Pixel Active Calorimeter Sensor (TPAC)

- 168×168 $50 \mu\text{m}$ pixels, $1 \times 1 \text{ cm}^2$.
- $0.18 \mu\text{m}$ process, deep p-well, 3T structures only.
- 4 test structures designed + 5 or $12 \mu\text{m}$ epitaxial layer.
- Per pixel trim (4 bits), mask (1-bit) and comparator.
- Only hits above threshold stored (zero-suppression).
- 400 ns timestamp with readout every 8192 timestamps (bunch train).



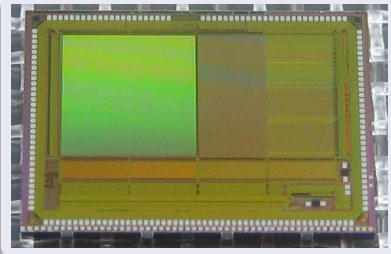
Cherwell 1 - Calorimetry/Tracking/Vertexing

4 test structures on 3 different epitaxial layers

- 1 **DECAL 25**: 48×96 $25 \mu\text{m}$ pixels with 2×2 summing.
- 2 **DECAL 50**: 24×48 $50 \mu\text{m}$ pixels.
- 3 **Reference**: 48×96 $25 \mu\text{m}$ pixels with ADC at column base.
- 4 **Strixel**: 48×96 $25 \mu\text{m}$ pixels with ADC embedded in pixel.

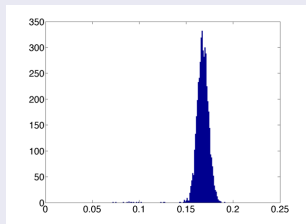
Additional features (in most variants)

- $0.5 \times 0.5 \text{ cm}^2$, digital readout.
- $0.18 \mu\text{m}$ process, 4T structures, CDS.
- 12-bit ADC, rolling shutter, stores 10 time slices.
- Global shutter for DECAL.
- Supports power pulsing.

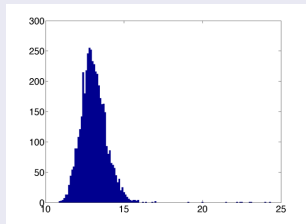


Cherwell 1 - Recent characterization work

Gain (ADC counts/ e^-)



Noise (ADC counts)

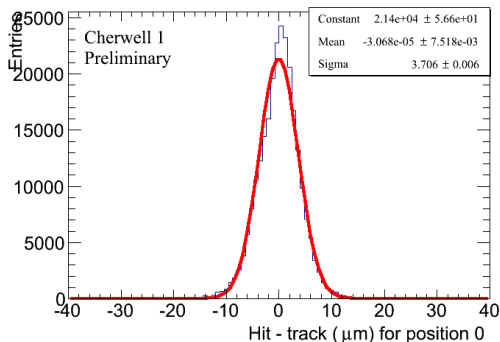


Preliminary results (May 2013)

- Noise 8-12 e^- rms depending on epitaxial layer.
- Gain 0.17 ADCs/ e^- or $51\mu V/e^-$.
- Full well 14700 e^- .
- Gain Stability $< 0.1\%/^{\circ}C$ between -50 to 50 $^{\circ}C$.
- Signal-to-Noise > 130 .

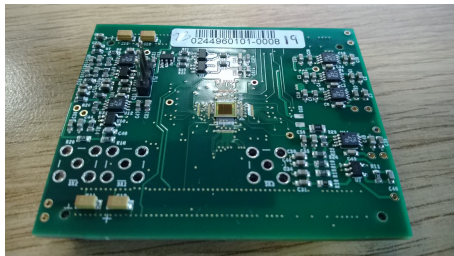
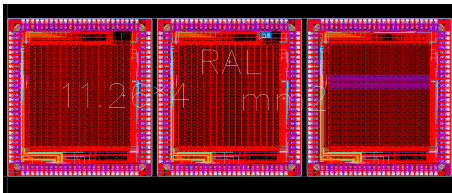
Hit Efficiency and Resolution from CERN test beam

- SVD fit to clusters along a road without sensor under consideration.
- No corrections for non-linear charge sharing ($< 1.5 \mu\text{m}$); multiple scattering ($< 0.5 \mu\text{m}$); and tracking resolution ($\sim 1 - 2 \mu\text{m}$).
- Hit efficiency $\gtrsim 99.7\%$.
- Hit resolution $3.7 \mu\text{m}$ without corrections achieved.



Cherwell 2 - ALICE Inner Tracker System prototype

- Based on Cherwell 1 experience.
- 3 variants, (2 x all digital, 1 x analogue FE).
- In-pixel circuitry, 128×128 pixels.
- Gain $38\mu\text{V}/e^-$, full well 18,000 e^- , dynamic range 2,900.
- Power 11 mW/cm².
- Rolling Shutter, Frame rate 21.76 μs .
- Readout speed $\gtrsim 500$ Mbit/sec.
- About to be characterized before going to test beam.
- **Will test at DESY in November.**



Cherwell 1 - Linear Collider

- Initial results have met or exceeded the original design goal.
- Hit efficiency ($\gtrsim 99.7\%$) and resolution ($3.7 \mu\text{m}$) looking good for future vertex and tracking devices.

Cherwell 2 - ALICE

- Sensor currently on test bench and being integrated into r/o system.
- Aim to characterize (PTC scans) in next few weeks.
- Test beam at DESY planned for mid-November. ALICE technology choice in 2014.
- **Cherwell 3** : New features and upgrades being designed for production and testing in 2014.

- **Cherwell 1**: Publish first results (2013/14).
- **DECAL** and **Strixel**: These blocks of the Cherwell 1 sensor will be re-characterized; hope to go to DESY next year and re-test (Jan 2014).
- **UK-MAPS**: If get money, will characterise **Lassena** sensor for LC (2014-2015).
- **ALICE ITS**: Hope our MAPS design will be chosen (2014-2018).
- **HV-CMOS**: ATLAS are intested in HV-CMOS for tracking in LHC Phase II (2014-2023).
- Looking at getting involved in LC - perhaps simulation of pixel tracker.